

# MC74HC11A

## Triple 3-Input AND Gate

### High-Performance Silicon-Gate CMOS

The MC74HC11A is identical in pinout to the LS11. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

#### Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 V to 6 V
- Low Input Current: 1  $\mu$ A
- High Noise Immunity Characteristic of CMOS Devices
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

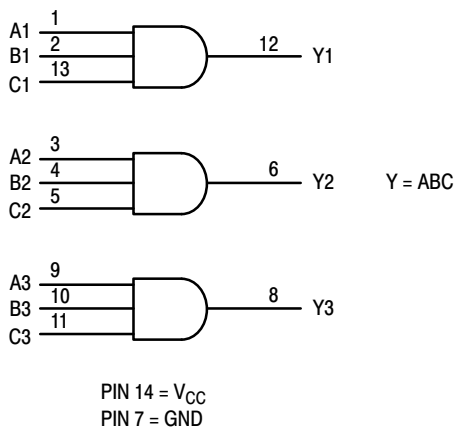


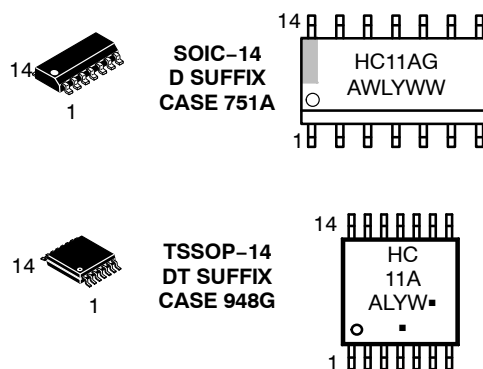
Figure 1. Logic Diagram



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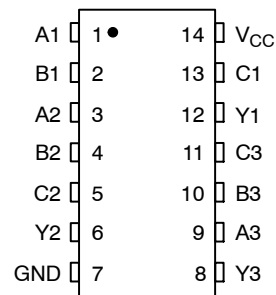
#### MARKING DIAGRAMS



A = Assembly Location  
WL, L = Wafer Lot  
YY, Y = Year  
WW, W = Work Week  
G or ■ = Pb-Free Package

(Note: Microdot may be in either location)

#### PIN ASSIGNMENT



#### FUNCTION TABLE

| Inputs |   |   | Output |
|--------|---|---|--------|
| A      | B | C | Y      |
| L      | X | X | L      |
| X      | L | X | L      |
| X      | X | L | L      |
| H      | H | H | H      |

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

# MC74HC11A

## MAXIMUM RATINGS\*

| Symbol    | Parameter                                                       | Value                  | Unit |
|-----------|-----------------------------------------------------------------|------------------------|------|
| $V_{CC}$  | DC Supply Voltage (Referenced to GND)                           | -0.5 to +7.0           | V    |
| $V_{in}$  | DC Input Voltage (Referenced to GND)                            | -0.5 to $V_{CC} + 0.5$ | V    |
| $V_{out}$ | DC Output Voltage (Referenced to GND)                           | -0.5 to $V_{CC} + 0.5$ | V    |
| $I_{in}$  | DC Input Current, per Pin                                       | $\pm 20$               | mA   |
| $I_{out}$ | DC Output Current, per Pin                                      | $\pm 25$               | mA   |
| $I_{CC}$  | DC Supply Current, $V_{CC}$ and GND Pins                        | $\pm 50$               | mA   |
| $P_D$     | Power Dissipation in Still Air<br>SOIC Package<br>TSSOP Package | 500<br>450             | mW   |
| $T_{stg}$ | Storage Temperature                                             | -65 to +150            | °C   |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

## RECOMMENDED OPERATING CONDITIONS

| Symbol                             | Parameter                                            | Min                     | Max             | Unit |    |
|------------------------------------|------------------------------------------------------|-------------------------|-----------------|------|----|
| V <sub>CC</sub>                    | DC Supply Voltage (Referenced to GND)                | 2.0                     | 6.0             | V    |    |
| V <sub>in</sub> , V <sub>out</sub> | DC Input Voltage, Output Voltage (Referenced to GND) | 0                       | V <sub>CC</sub> | V    |    |
| T <sub>A</sub>                     | Operating Temperature, All Package Types             | −55                     | +125            | °C   |    |
| t <sub>r</sub> , t <sub>f</sub>    | Input Rise and Fall Time<br>(Figure 2)               | V <sub>CC</sub> = 2.0 V | 0               | 1000 | ns |
|                                    |                                                      | V <sub>CC</sub> = 3.0 V | 0               | 600  |    |
|                                    |                                                      | V <sub>CC</sub> = 4.5 V | 0               | 500  |    |
|                                    |                                                      | V <sub>CC</sub> = 6.0 V | 0               | 400  |    |

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## DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol          | Parameter                                      | Test Conditions                                                                     | V <sub>CC</sub><br>V     | Guaranteed Limit          |                           |                           | Unit |
|-----------------|------------------------------------------------|-------------------------------------------------------------------------------------|--------------------------|---------------------------|---------------------------|---------------------------|------|
|                 |                                                |                                                                                     |                          | - 55 to 25°C              | ≤ 85°C                    | ≤ 125°C                   |      |
| V <sub>IH</sub> | Minimum High-Level Input Voltage               | V <sub>out</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V<br> I <sub>out</sub>   ≤ 20 μA  | 2.0<br>3.0<br>4.5<br>6.0 | 1.5<br>2.1<br>3.15<br>4.2 | 1.5<br>2.1<br>3.15<br>4.2 | 1.5<br>2.1<br>3.15<br>4.2 | V    |
| V <sub>IL</sub> | Maximum Low-Level Input Voltage                | V <sub>out</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V<br> I <sub>out</sub>   ≤ 20 μA  | 2.0<br>3.0<br>4.5<br>6.0 | 0.5<br>0.9<br>1.35<br>1.8 | 0.5<br>0.9<br>1.35<br>1.8 | 0.5<br>0.9<br>1.35<br>1.8 | V    |
| V <sub>OH</sub> | Minimum High-Level Output Voltage              | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20 μA | 2.0<br>4.5<br>6.0        | 1.9<br>4.4<br>5.9         | 1.9<br>4.4<br>5.9         | 1.9<br>4.4<br>5.9         | V    |
|                 |                                                | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub>  I <sub>out</sub>   ≤ 2.4 mA   | 3.0                      | 2.48                      | 2.34                      | 2.20                      |      |
|                 |                                                | I <sub>out</sub>   ≤ 4.0 mA                                                         | 4.5                      | 3.98                      | 3.84                      | 3.70                      |      |
|                 |                                                | I <sub>out</sub>   ≤ 5.2 mA                                                         | 6.0                      | 5.48                      | 5.34                      | 5.20                      |      |
| V <sub>OL</sub> | Maximum Low-Level Output Voltage               | V <sub>in</sub> = V <sub>IH</sub><br> I <sub>out</sub>   ≤ 20 μA                    | 2.0<br>4.5<br>6.0        | 0.1<br>0.1<br>0.1         | 0.1<br>0.1<br>0.1         | 0.1<br>0.1<br>0.1         | V    |
|                 |                                                | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub>  I <sub>out</sub>   ≤ 2.4 mA   | 3.0                      | 0.26                      | 0.33                      | 0.40                      |      |
|                 |                                                | I <sub>out</sub>   ≤ 4.0 mA                                                         | 4.5                      | 0.26                      | 0.33                      | 0.40                      |      |
|                 |                                                | I <sub>out</sub>   ≤ 5.2 mA                                                         | 6.0                      | 0.26                      | 0.33                      | 0.40                      |      |
| I <sub>in</sub> | Maximum Input Leakage Current                  | V <sub>in</sub> = V <sub>CC</sub> or GND                                            | 6.0                      | ± 0.1                     | ± 1.0                     | ± 1.0                     | μA   |
| I <sub>CC</sub> | Maximum Quiescent Supply Current (per Package) | V <sub>in</sub> = V <sub>CC</sub> or GND<br>I <sub>out</sub> = 0 μA                 | 6.0                      | 1                         | 10                        | 40                        | μA   |

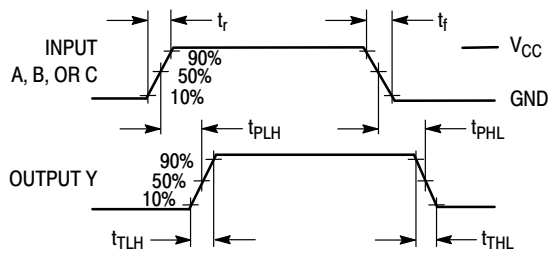
## AC ELECTRICAL CHARACTERISTICS (C<sub>L</sub> = 50 pF, Input t<sub>r</sub> = t<sub>f</sub> = 6 ns)

| Symbol                                 | Parameter                                                                    | V <sub>CC</sub><br>V     | Guaranteed Limit     |                       |                       | Unit |
|----------------------------------------|------------------------------------------------------------------------------|--------------------------|----------------------|-----------------------|-----------------------|------|
|                                        |                                                                              |                          | - 55 to 25°C         | ≤ 85°C                | ≤ 125°C               |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Input A, B, or C to Output Y<br>(Figures 2 and 3) | 2.0<br>3.0<br>4.5<br>6.0 | 95<br>45<br>19<br>16 | 120<br>60<br>24<br>20 | 145<br>75<br>29<br>25 | ns   |
| t <sub>TLH</sub> ,<br>t <sub>THL</sub> | Maximum Output Transition Time, Any Output<br>(Figures 2 and 3)              | 2.0<br>3.0<br>4.5<br>6.0 | 75<br>30<br>15<br>13 | 95<br>40<br>19<br>16  | 110<br>55<br>22<br>19 | ns   |
| C <sub>in</sub>                        | Maximum Input Capacitance                                                    | –                        | 10                   | 10                    | 10                    | pF   |

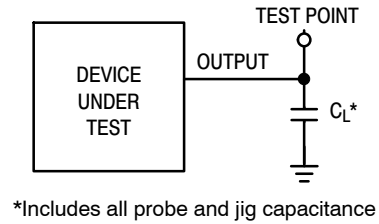
|                 |                                           |                                         |    |
|-----------------|-------------------------------------------|-----------------------------------------|----|
| C <sub>PD</sub> | Power Dissipation Capacitance (Per Gate)* | Typical @ 25°C, V <sub>CC</sub> = 5.0 V | pF |
|                 |                                           | 27                                      |    |

\*Used to determine the no-load dynamic power consumption: P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub>2f + I<sub>CC</sub> V<sub>CC</sub>.

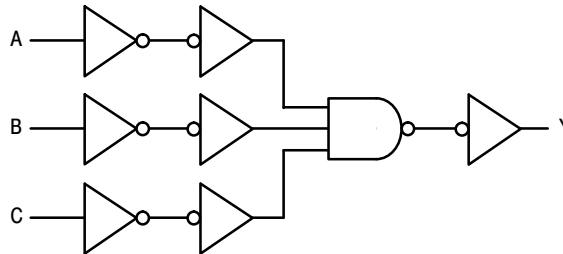
# MC74HC11A



**Figure 2. Switching Waveforms**



**Figure 3. Test Circuit**



**Figure 4. Expanded Logic Diagram  
(1/3 of the Device)**

## ORDERING INFORMATION

| Device          | Package               | Shipping <sup>†</sup> |
|-----------------|-----------------------|-----------------------|
| MC74HC11ADG     | SOIC-14<br>(Pb-Free)  | 55 Units / Rail       |
| MC74HC11ADR2G   | SOIC-14<br>(Pb-Free)  | 2500 / Tape & Reel    |
| MC74HC11ADTR2G  | TSSOP-14<br>(Pb-Free) | 2500 / Tape & Reel    |
| NLV74HC11ADR2G* | SOIC-14<br>(Pb-Free)  | 2500 / Tape & Reel    |

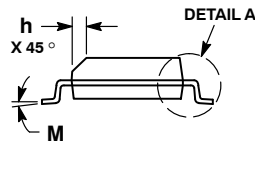
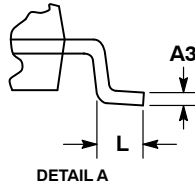
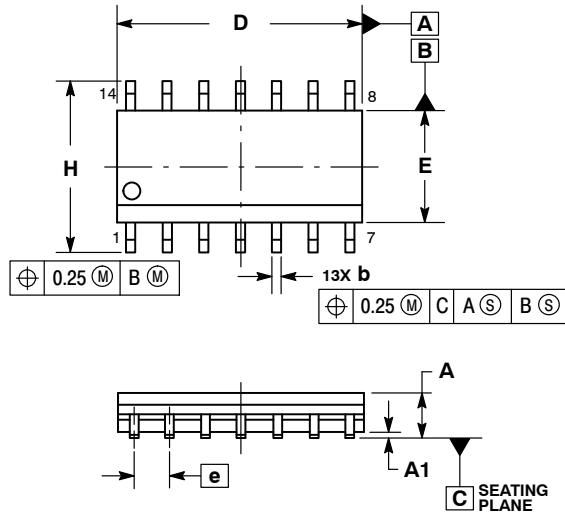
<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

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## PACKAGE DIMENSIONS

**SOIC-14 NB**  
CASE 751A-03  
ISSUE K

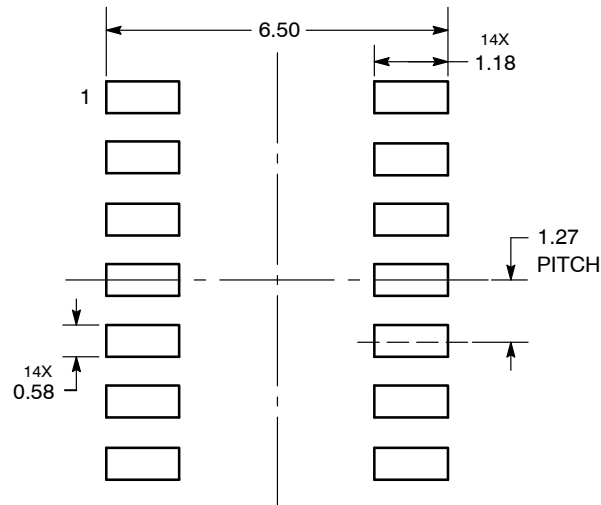


### NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF AT MAXIMUM MATERIAL CONDITION.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSIONS.
5. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 1.35        | 1.75 | 0.054     | 0.068 |
| A1  | 0.10        | 0.25 | 0.004     | 0.010 |
| A3  | 0.19        | 0.25 | 0.008     | 0.010 |
| b   | 0.35        | 0.49 | 0.014     | 0.019 |
| D   | 8.55        | 8.75 | 0.337     | 0.344 |
| E   | 3.80        | 4.00 | 0.150     | 0.157 |
| e   | 1.27 BSC    |      | 0.050 BSC |       |
| H   | 5.80        | 6.20 | 0.228     | 0.244 |
| h   | 0.25        | 0.50 | 0.010     | 0.019 |
| L   | 0.40        | 1.25 | 0.016     | 0.049 |
| M   | 0°          | 7°   | 0°        | 7°    |

### SOLDERING FOOTPRINT\*



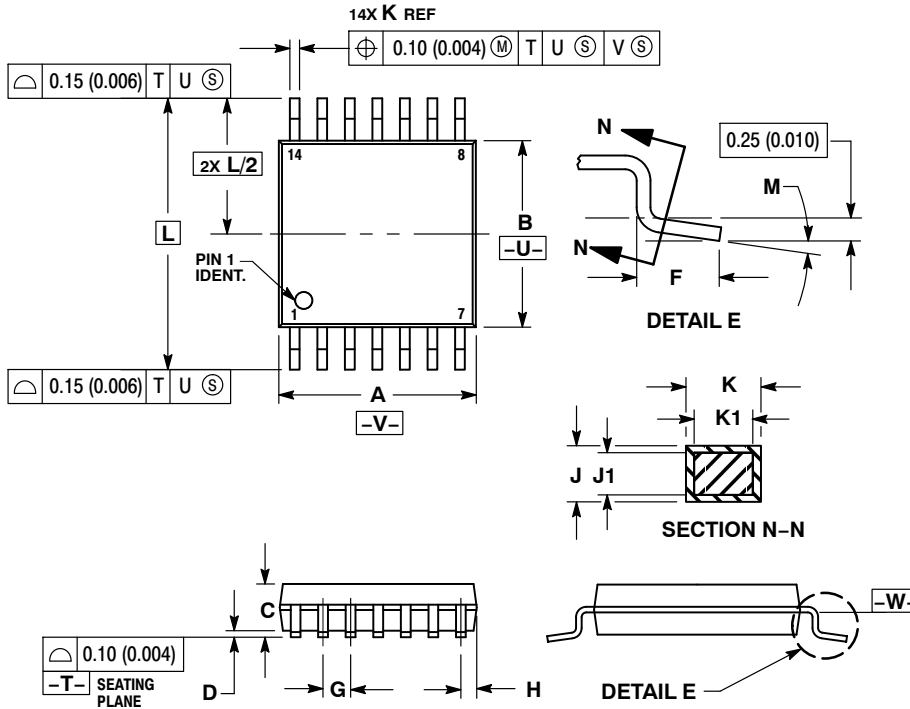
DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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## PACKAGE DIMENSIONS

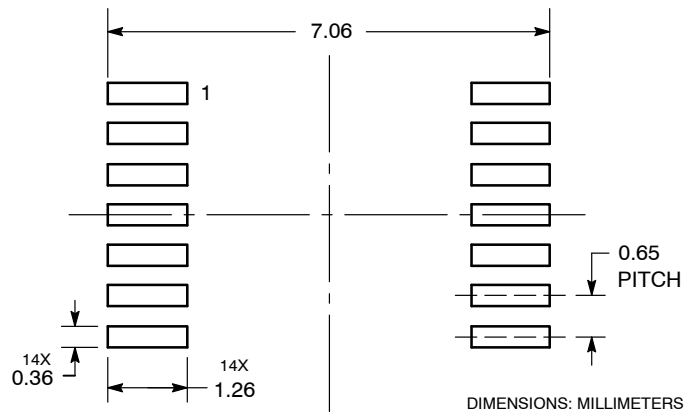
**TSSOP-14**  
CASE 948G-01  
ISSUE B



### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

# MC74HC11A

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**MC74HC11A/D**

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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
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- Работу по проектам и поставку образцов.
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- Тестирование поставляемой продукции.
- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
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- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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